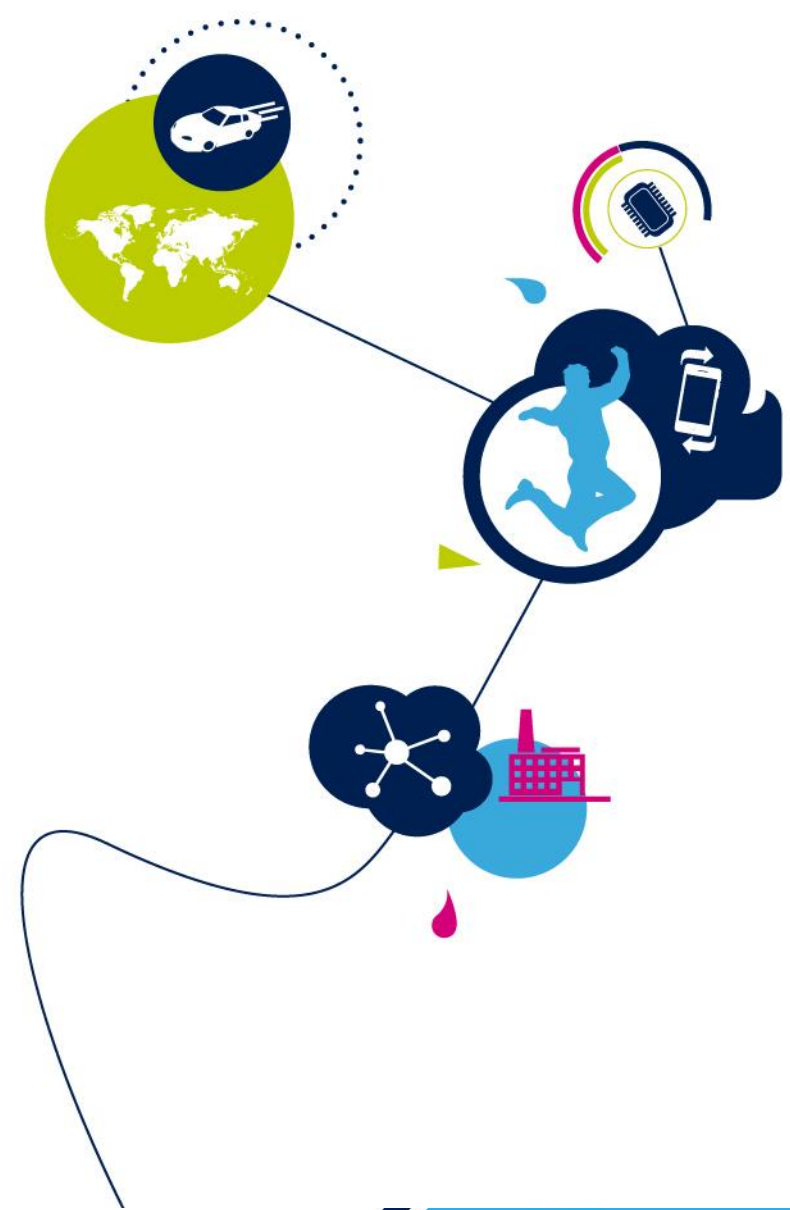


Predictive Maintenance: Use of Advanced Sensors in Smart Industry Applications

Ernesto Manuel CANTONE

AME IoT Marketing



**ST Developers
Conference**

September 12th, 2019
Santa Clara Convention Center - Mission City Ballroom
Santa Clara, CA



What is “Smart Industry”?

2

- Industry 1.0: Mechanization, Steam Power
- Industry 2.0: Mass Production, Assembly Line, Electrical Energy
- Industry 3.0: Automation, Computers and Electronics
- Industry 4.0: Cyber Physical Systems, IoT, Networks



Smart Industry

Scope and Goals

3

More efficient
operation

Less waste

Producing more **efficiently**
and in more **environmentally**
friendly manner

Responding to demand more
flexibly and with more
customization

Local, mass
customized production

Safer working
environments

Evolved man-machine
cooperation

With a better and safer **human**
experience

Collecting and
using manufacturing and
supply chain **data** better

Big data
& Cloud computing



Predictive Maintenance

A Smart Industry hot topic

4

Maintenance is a set of actions to keep a machine working properly

Preventive Maintenance



Scheduled maintenance tasks based on a time schedule – don't care of the actual status of the equipment

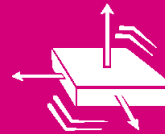
Advantages

- Simple to plan

Drawbacks

- Maintenance may happen too late (or too early)
- Maintenance may not be necessary

Condition Based Maintenance



Maintenance is based on the estimated conditions of the machine, typically monitored through inspection or sensors

Advantages

- Maintenance only takes place when necessary

Drawbacks

- Maintenance only after machine begins to show signs of failure

Predictive Maintenance



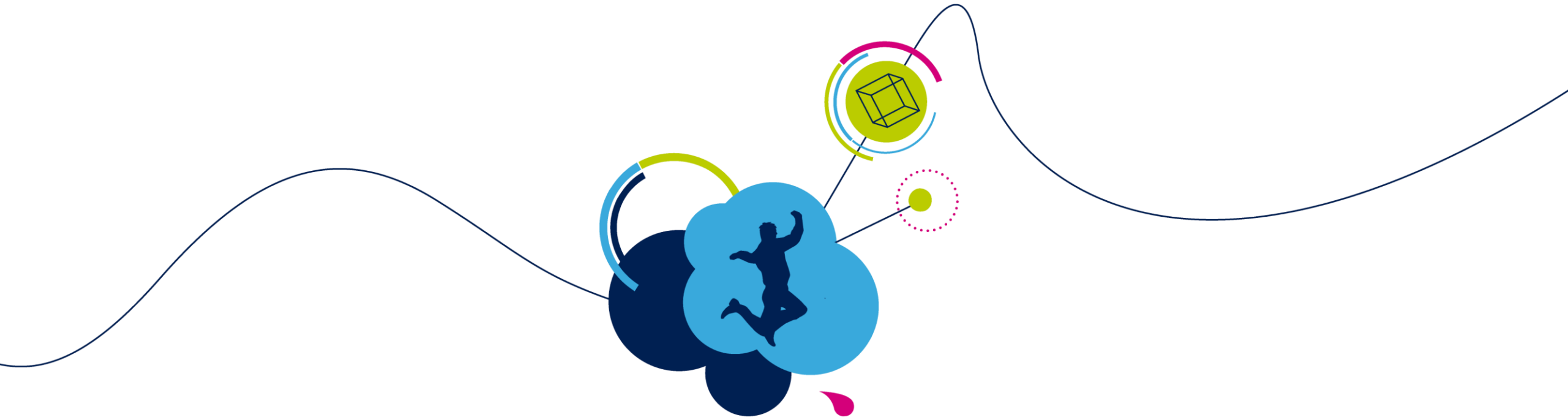
Maintenance actions predicted in advance based on monitoring combined with a dynamic predictive model for failure analysis

Advantages

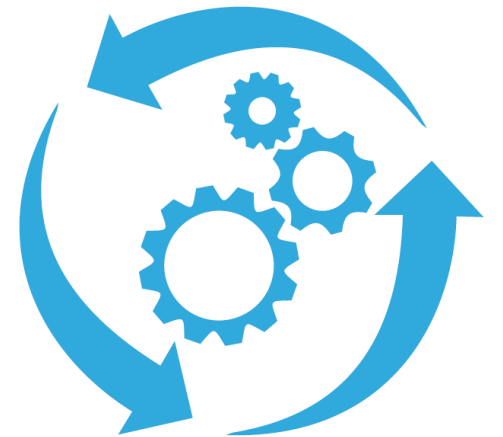
- Maintenance optimized for machine life and production efficiency

Drawbacks

- Requires complex overall system



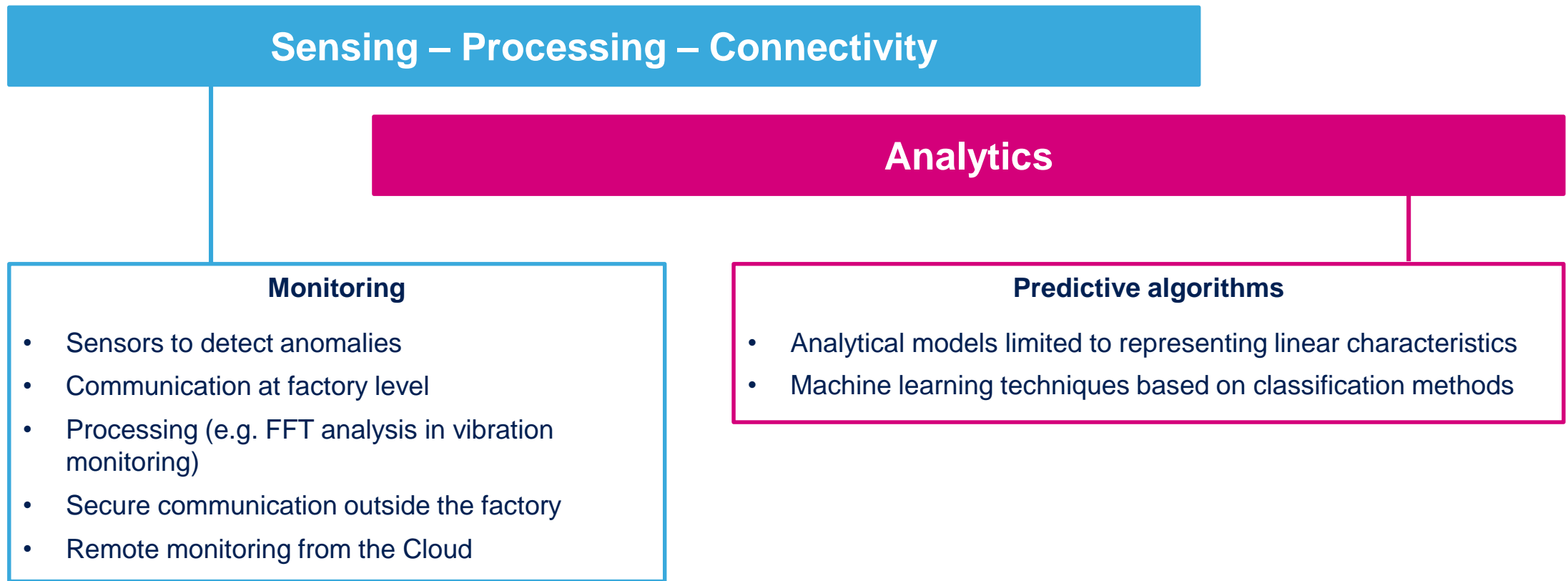
Predictive Maintenance Architecture



Architecture for Predictive Maintenance

6

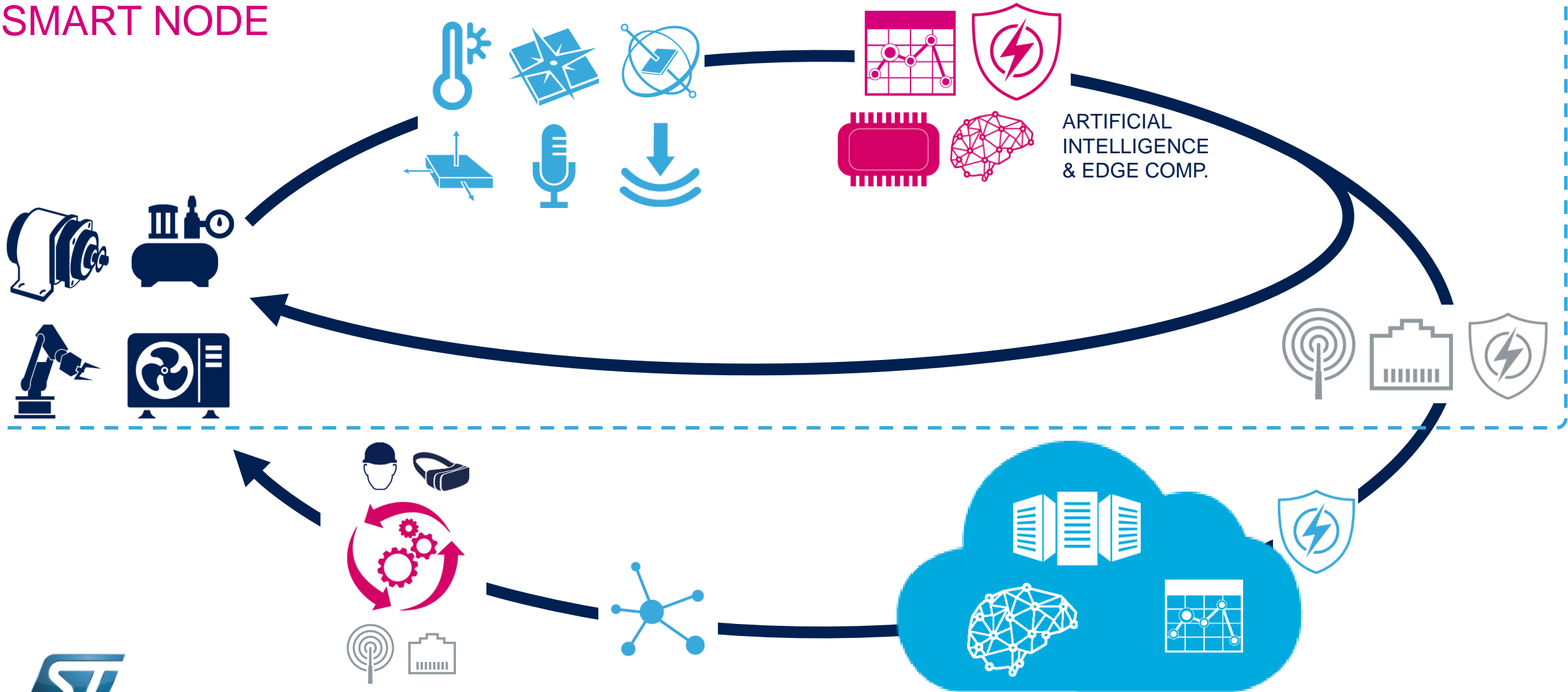
Low power / Scalable / Secure / Real-time



Smart Industry: Trends and Enablers

7

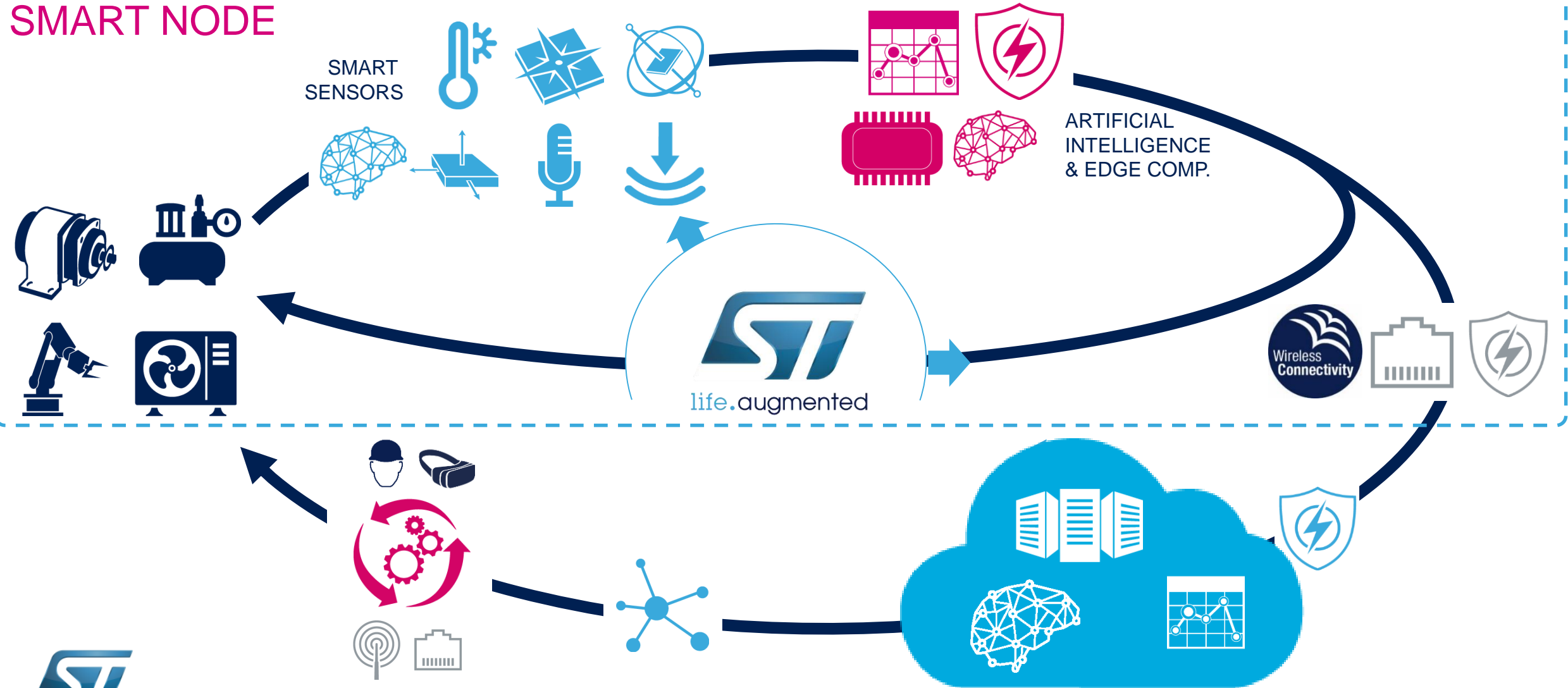
SMART NODE



Smart Industry: Trends and Enablers

8

SMART NODE





Sensors Technologies and Predictive Maintenance

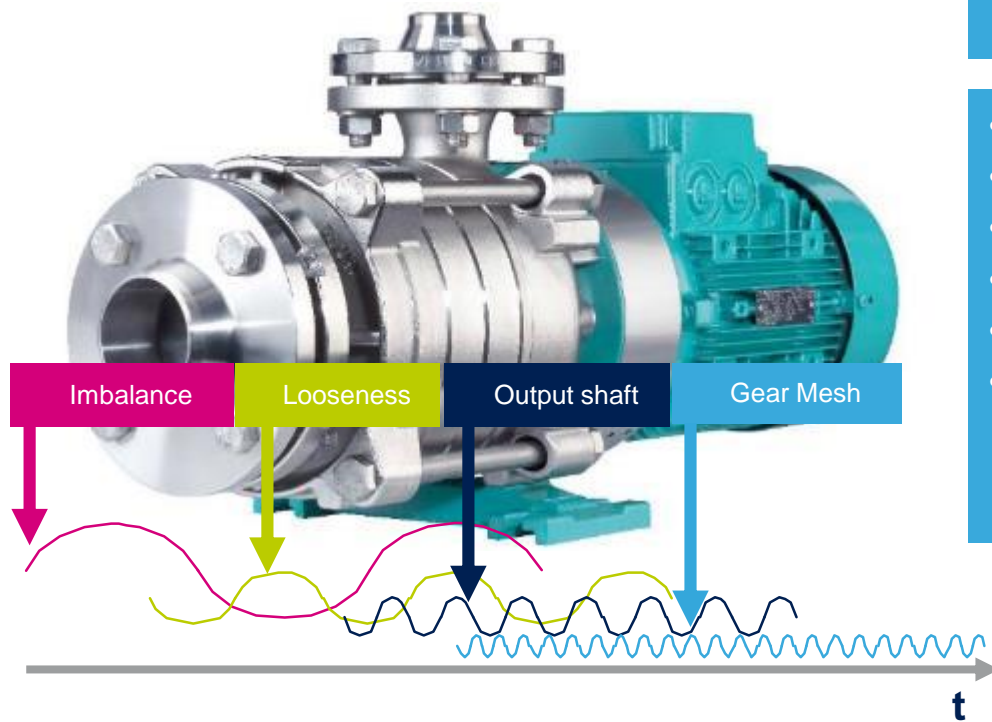


Monitoring of an Industrial Motor

Typical Use Case

10

Any parameter deviation is an indicator of potential failure



Mechanical vibration

- Displacement
- Speed
- Acceleration
- Acoustic noise
- Angular speed
- Torque

Thermal

- Winding temperature
- Bearing temperature

Electromagnetic

- Current
- Voltage
- Electrostatic discharge
- Magnetic flux – internal
- Magnetic flux – external

Monitoring and Predictive Maintenance

Use of Environmental Sensors

11

Key components for process and quality control in industrial applications

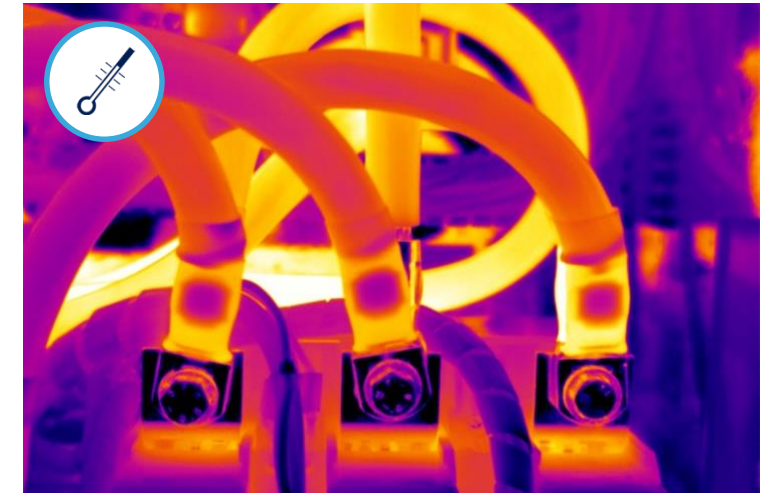
Pressure measurements for **"air management" systems**, which monitor the performance indicators and the different stages of the air compressors connected to the compressed-air supply grid



Humidity sensors are adopted in **HVAC systems** to control water vapor level or to help in regulating parameters such as air temperature and blowing speed



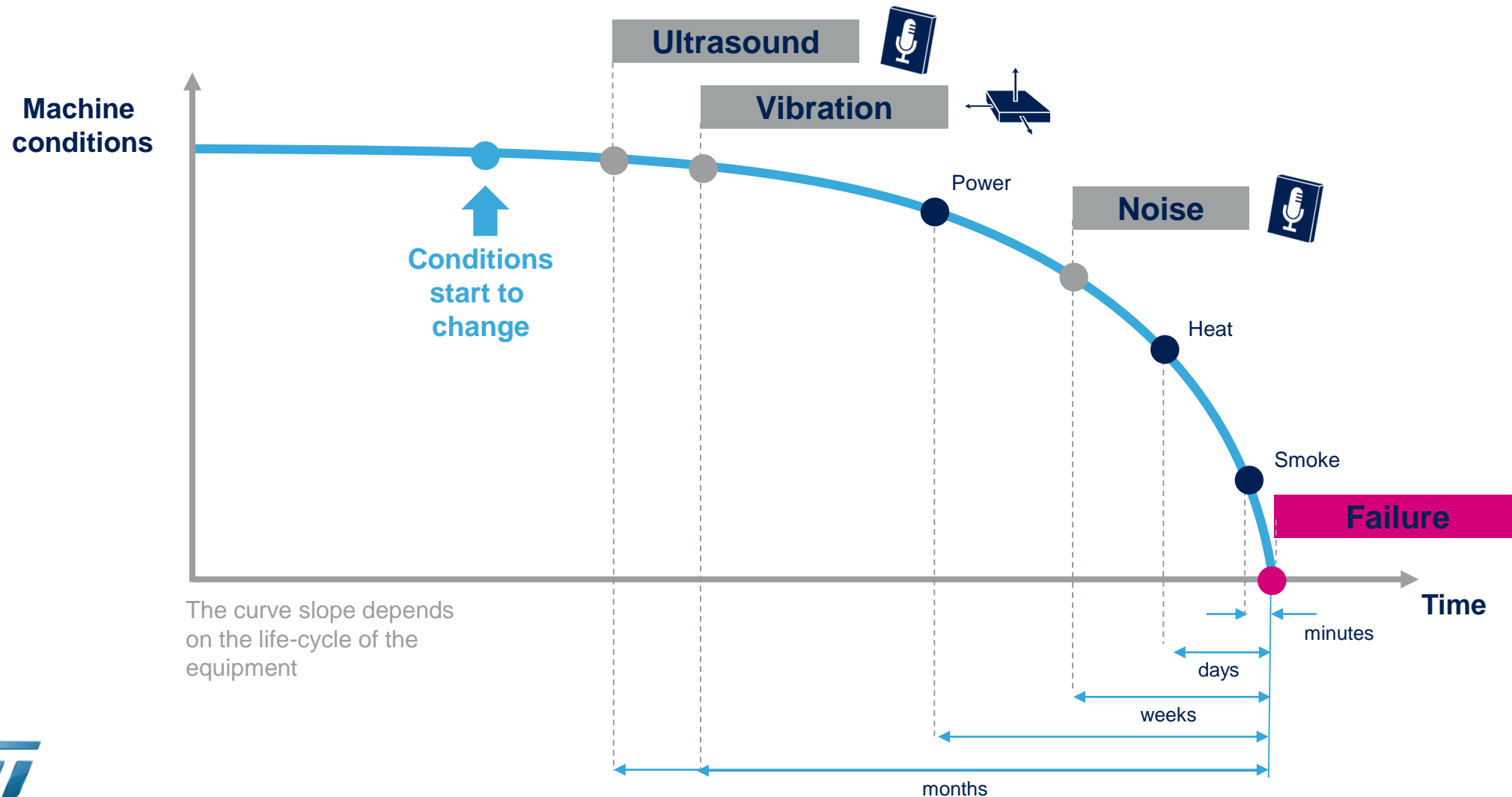
Measuring **operating temperatures** is crucial for detecting losses or improperly terminated electrical connections, overloading, defective contacts, phase imbalances and other electrical issues



Accelerometer and Microphone

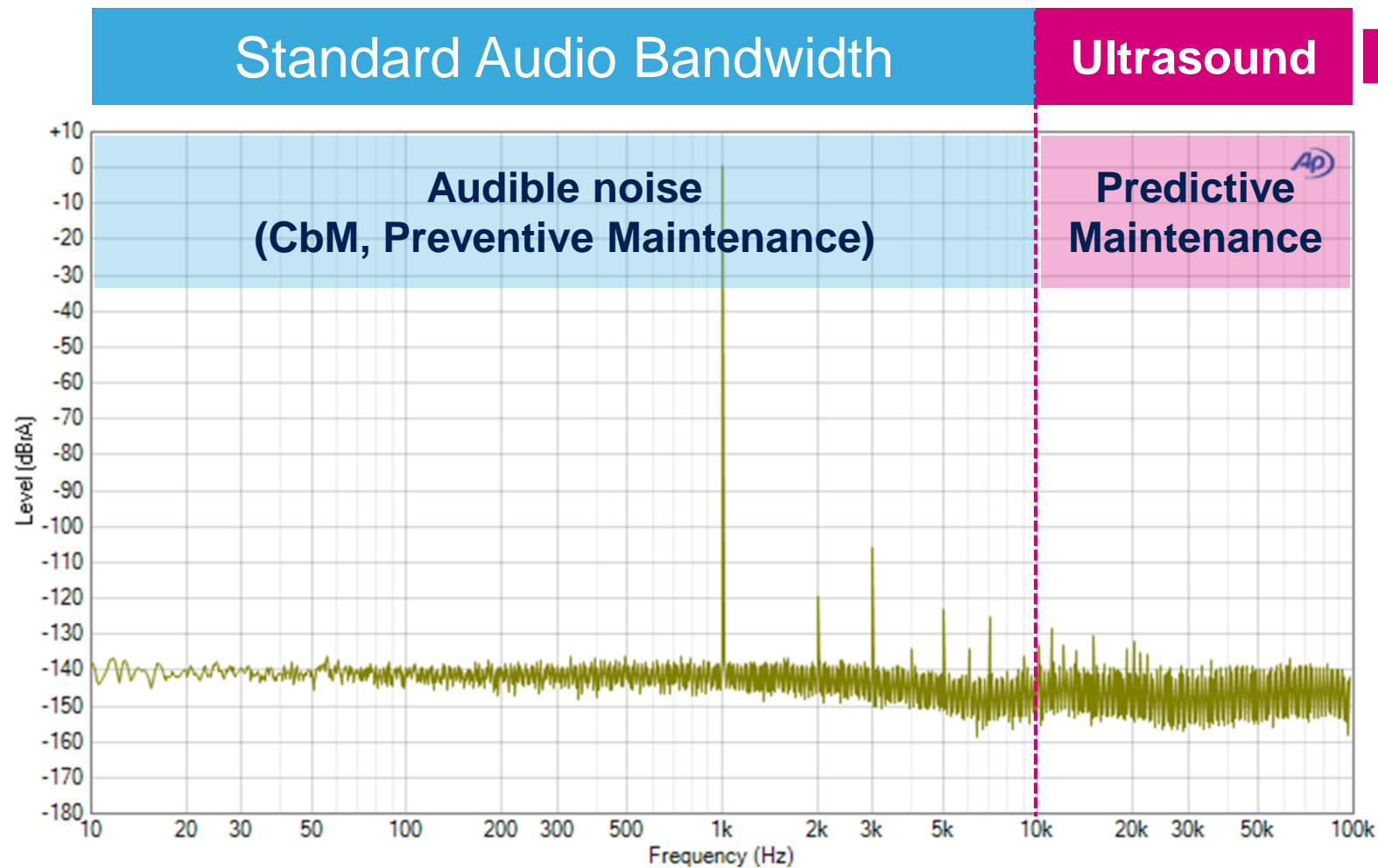
Distinctive sensors for Predictive Maintenance

12



Standard Audio vs Ultrasound

13



Post processing analysis
Ultrasound frequencies
to **detect** and **classify** leaks

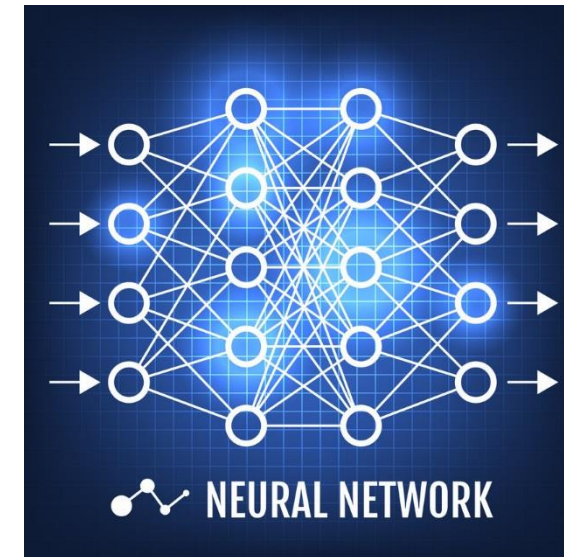
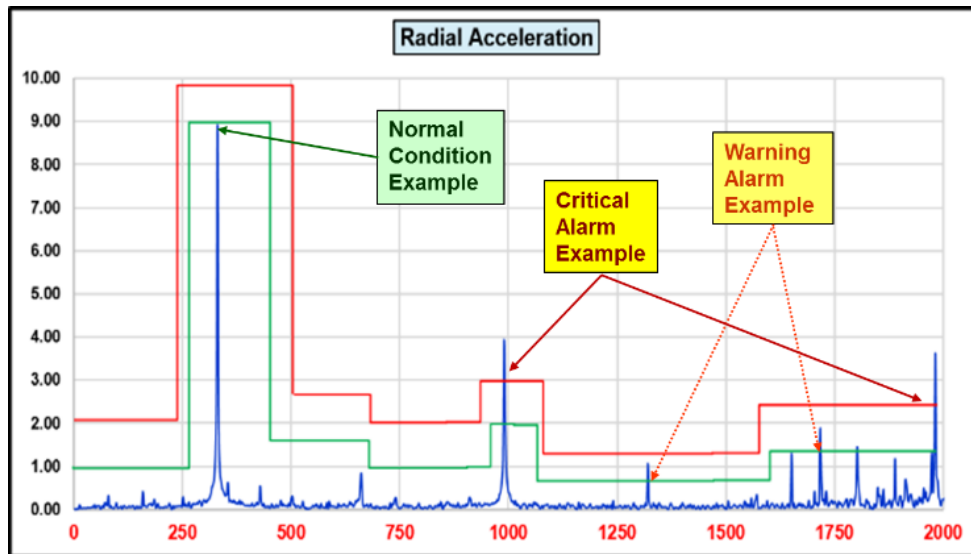
Most common maintenance applications

- Air Leak Detection of compressed air equipment
- Vibration monitor
- Compressor Valve Inspections
- Acoustic Lubrication
- Heat Exchanger and Condenser Leaks
- Hydraulic Systems
- Pump Cavitation

While FFT are widely used, Deep Learning and AI can enable new scenarios

- **Embedded FFT** analysis on the sensor can **isolate vibration**
- **Alarm** can be set according to specific threshold to detect potential defects

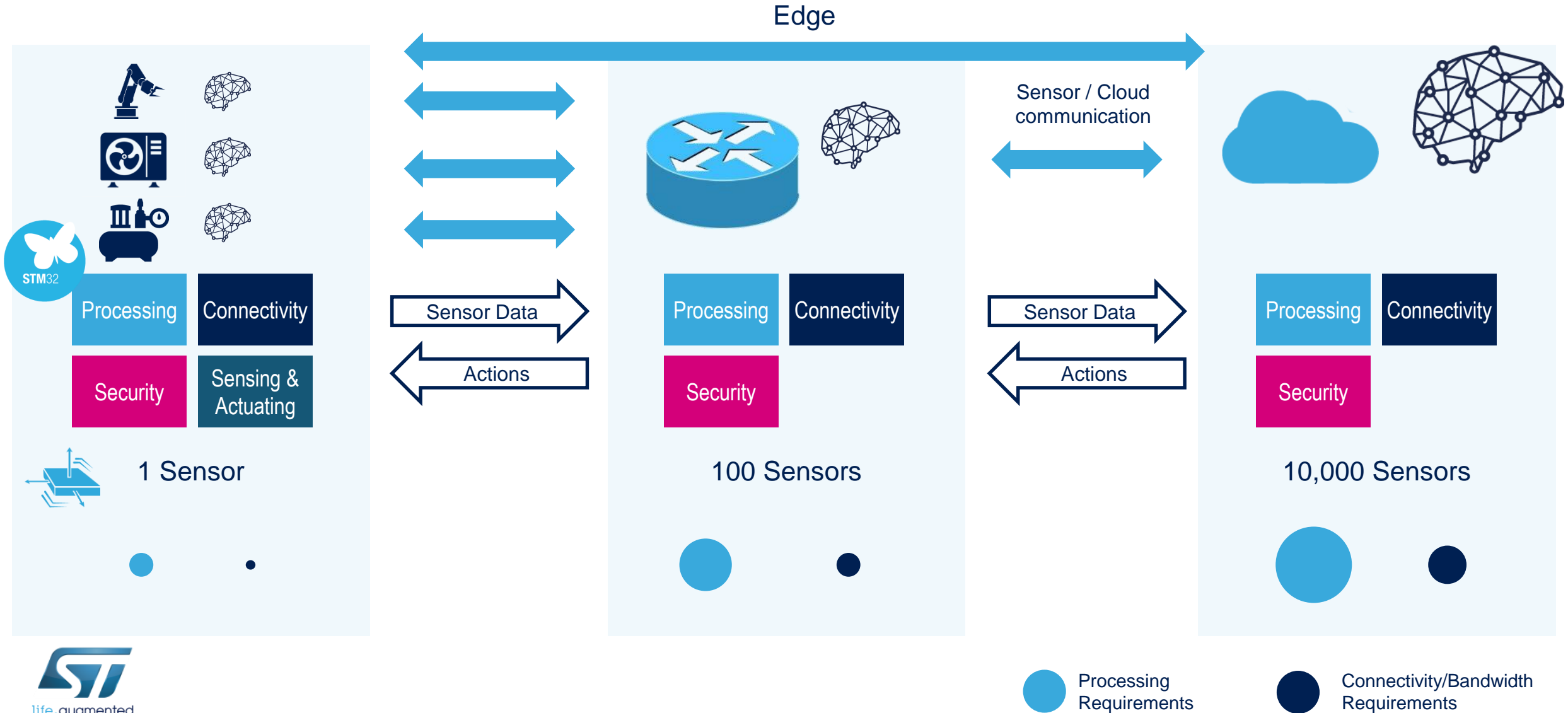
- **AI** improves the data analysis (vs FFT) hence the capabilities of failure prediction
- AI models, resulting on a “learning process” can be distilled down into a **Neural Network hosted into MCUs** or even down to new generation of smart sensors.



Predictive Maintenance

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ST enables new approaches with a distributed architecture

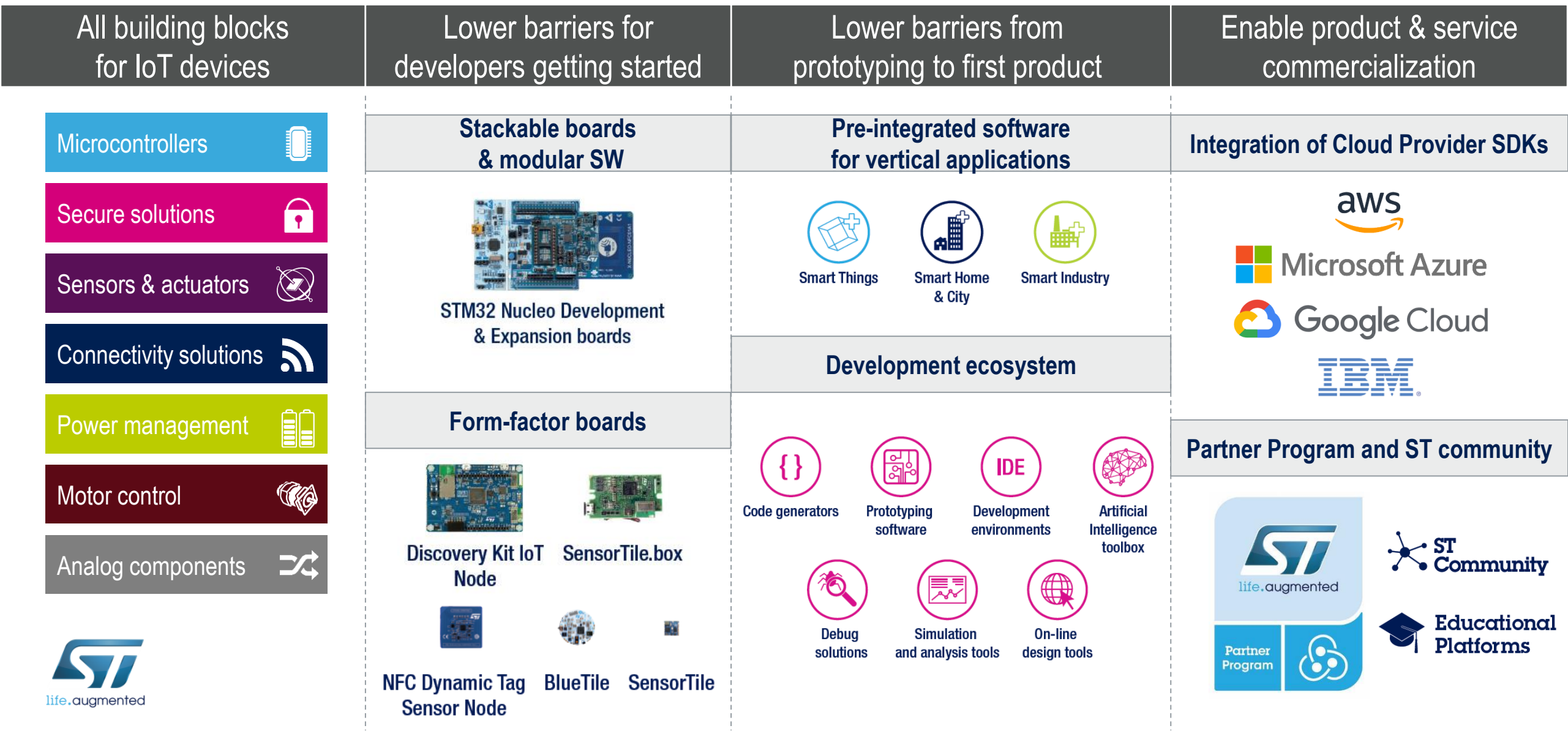




ST Enablers: Products and Solutions

Complete Ecosystem Offering by ST

17



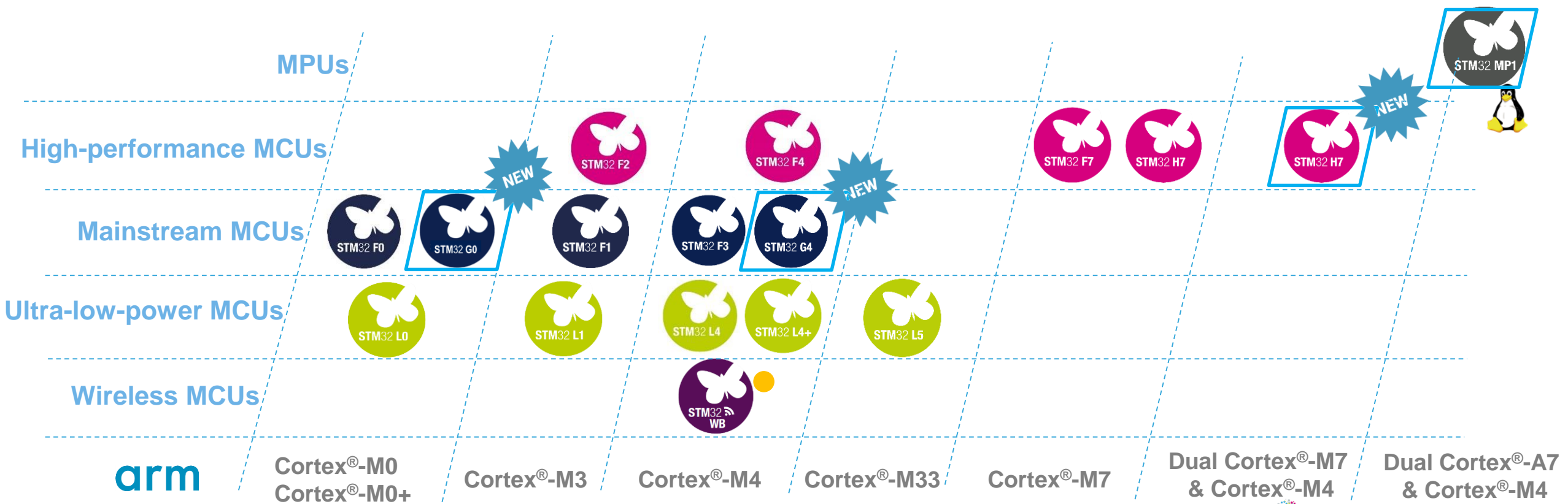


Microcontrollers and Microprocessors



Today - STM32 Portfolio Positioning

15 product series / More than 50 product lines / ~1000 products



arm

Cortex®-M0
Cortex®-M0+

Cortex®-M3

Cortex®-M4

Cortex®-M33

Cortex®-M7

Dual Cortex®-M7
& Cortex®-M4

Dual Cortex®-A7
& Cortex®-M4



Note ● : Cortex-M0+ Radio Co-processor

More than
40,000 customers



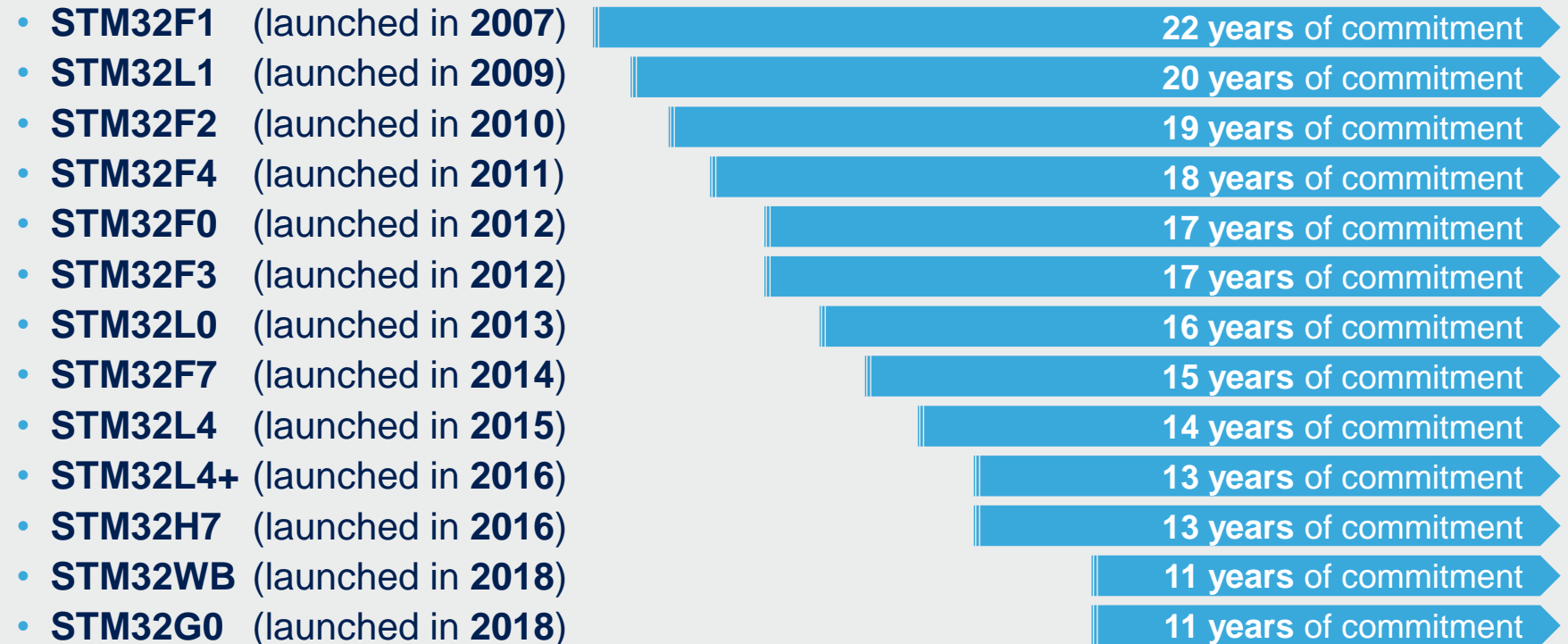
STM32 Rolling Longevity Commitment

20

Longevity commitment is renewed every year



starting January
1st 2019
→ Until 2029



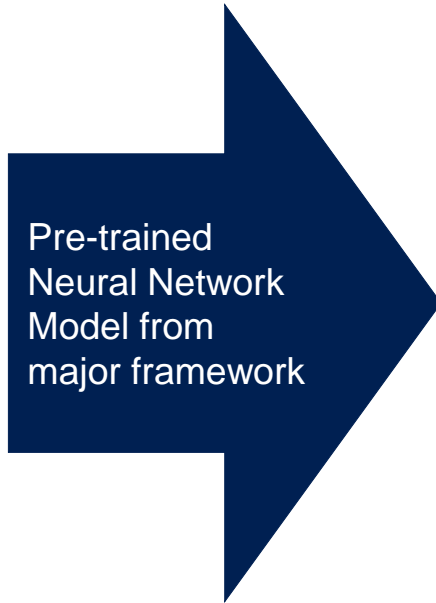
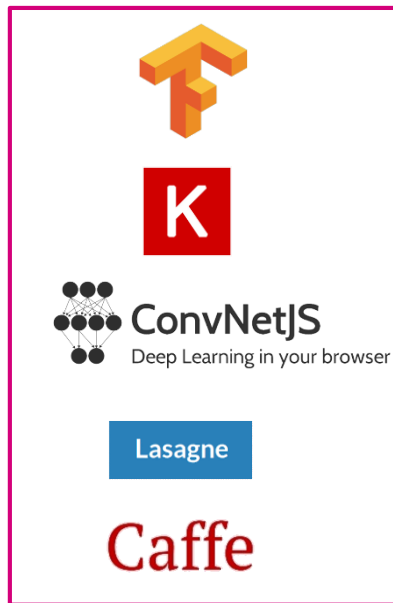
STM32 Artificial Intelligence

Neural Networks for STM32

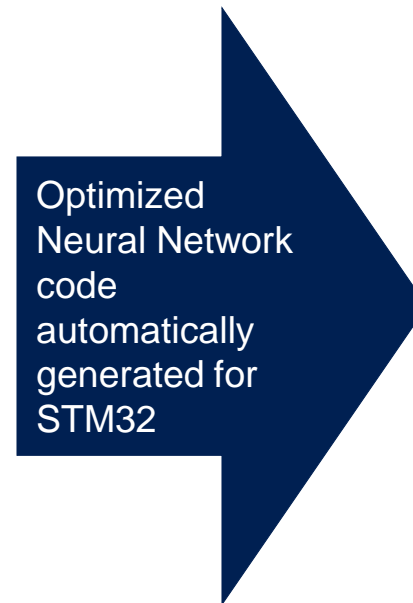
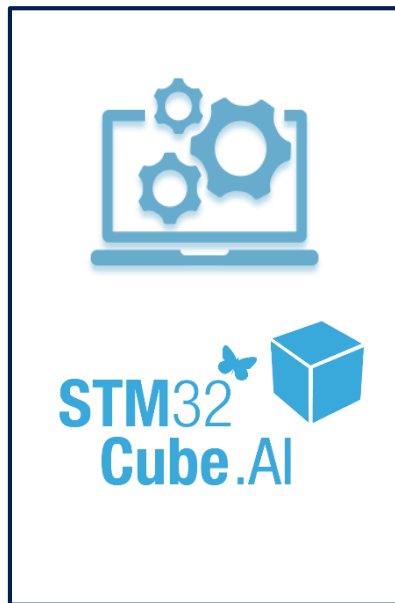
21

STM32Cube.AI SW tool allows our customers to innovate...

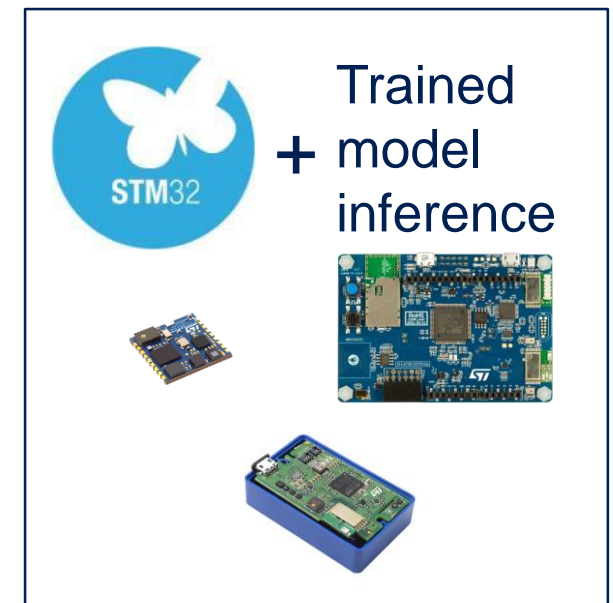
Off-the-shelf tools



ST SW tools



ST AI solution



... bringing AI into the STM32 Portfolio



Sensors



A Broad Sensor Portfolio

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Market leading
#1 in the
Consumer
MEMS segment

 Motion sensors
40% share (#1)

 Pressure sensors
31% share (#2)



IHS Motion Sensors Market
Share Report 2017



New sensors
portfolio for
Industrial
applications



Broadest sensors
portfolio
addressing
Personal
Electronics,
Industrial &
Automotive



High stability
IMU for
Always ON
applications,
finite state
machine, w/
I3C Interface



MIPI I3C -- High
Performance
Interface &
Scalable solution

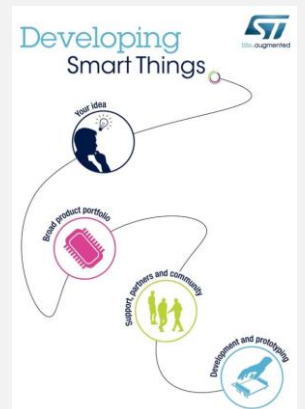


IMU = Inertial
Measurement Unit

Unique Pressure
Sensors portfolio:
Dust and **Water**
resistant
packages



Complete
system
solutions
and official
Partners for
fast go-to-
market





10-Year Product Longevity

Benefits

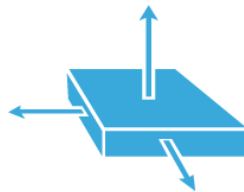
10-YEAR
LONGEVITY FROM
PRODUCT
INTRODUCTION
DATE

DESIGN AND
MANUFACTURING
FOR HIGHER
ROBUSTNESS &
PERFORMANCES

CALIBRATION &
TESTING FOR
HIGHER
ACCURACY &
QUALITY

EXTENDED
TEMPERATURE
RANGE AND
ENDURANCE TO
SHOCK AND
VIBRATION

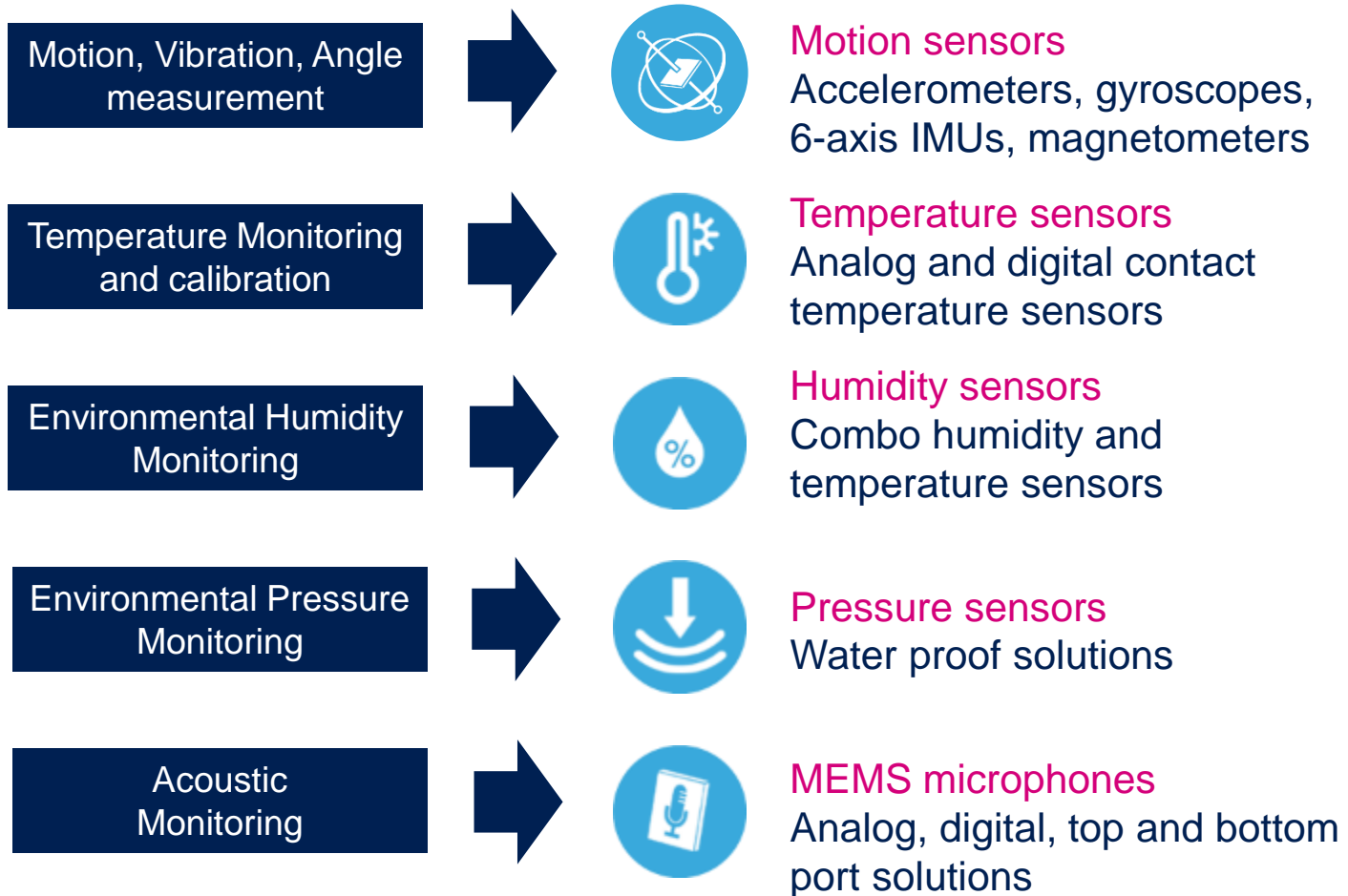
Growing Product Family

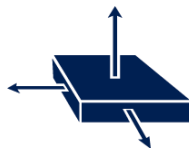


Motion Sensors and more

25

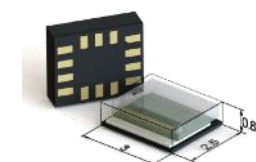
Humidity and temperature sensors as enablers for in-situ calibration





IIS3DWB

Accelerometer - Ultra Wide Bandwidth



LGA-14 2.5x3 mm

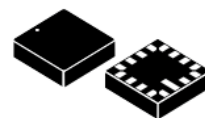


3D Accelerometer – 16g Full Scale
Digital Output
Ultra Wide Bandwidth (to 5 kHz)
Ultra Low Noise
Up to 105°C Operating Temp



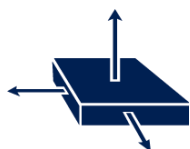
IIS3DHHC/IIS2ICLH*

Inclinometer
High Resolution, Ultra Low Power



LGA-16 5x5 mm

Inclinometer – Digital Output
High Accuracy (<0.5° over Temp. and Time)
Ultra Low Current consumption: 400 uA



IIS2DH/IIS2DLPC

Accelerometer - Wide Bandwidth, Ultra-low-power



LGA-12 2x2 mm

3D Accelerometer – Digital Output
Wide Bandwidth (up to 2.3 kHz)
Ultra Low Power – Ultra Compact



IIS2MDC

Magnetometer Low-Noise, Low Power



LGA-12 2x2 mm

3D Magnetometer – Digital Output
AMR Technology - up to 50 Gauss Full Scale
Ultra Low Noise, Low Power

Motion MEMS Sensors for Smart Industry



ISM330DLC

Combo accelerometer & Gyroscope
Wide Bandwidth



LGA-14 2.5x3 mm

3D accelerometer with full scale up to $\pm 16g$
3D gyroscope with full scale up to ± 2000 dps
Accelerometer with Wide Bandwidth (up to 3 kHz)
Ultra Low Power and Smart Features



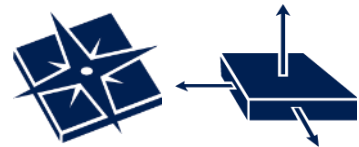
ISM330DHCX

Combo accelerometer & Gyroscope
Wide Bandwidth



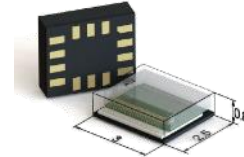
LGA-14 2.5x3 mm

3D accelerometer with full scale up to $\pm 16g$
3D gyroscope with full scale up to ± 4000 dps
Accelerometer with Wide Bandwidth (up to 3 kHz)
Ultra Low Power and Machine Learning Core



ISM303DAC

E-Compass
Combo Accelerometer and Magnetometer



LGA-12 2x2 mm

3D Accelerometer – Digital Output
3D Magnetometer – Digital Output
 $\pm 2/\pm 4/\pm 8/\pm 16$ g selectable acceleration full scales
Up to ± 50 gauss magnetic dynamic range

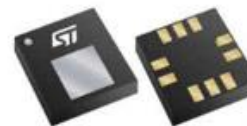
Environmental Sensors for Smart Industry

28



LPS22HH

Pressure Sensor – High Accuracy – Compact Size



HLGA-10L 2x2x0.76 mm

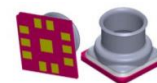
Absolute Pressure Sensor
260 to 1260 hPa Range - Digital Output
High Accuracy (± 0.75 hPa)
Low noise (0.75 Pa RMS)
Ultra Compact full molded package

LPS33W/LPS27HHW

Pressure Sensor – Water Resistant



3.3x3.3x2.9 mm



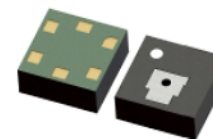
2.7 x 2.7 x 1.7 mm

Absolute Pressure Sensor
260 to 1260 hPa Range - Digital Output
High Accuracy (± 2.5 hPa / ± 0.5 hPa)
Low noise (0.8 Pa / 0.7 Pa)
Water resistant up to 10 ATM



HTS221

Humidity and Temp Sensor – High Accuracy



HLGA-6 2x2x0.9 mm

Humidity and Temperature Sensor
Digital Output
High Accuracy:
• Humidity: ± 3.5 %RH
• Temperature: ± 0.5 deg
Low Power



STTS751

Digital Temperature Sensor

UDFN-6L or SOT23-6L

Accuracy ± 1.0 °C ; Programmable resolution

LM235 – STLM20

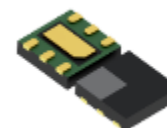
Analog Temperature Sensor

TO92/SO8

Accuracy ± 1.0 °C ; Op. Temp up to 150 °C

STTS22H*

Digital Temperature Sensor – High Accuracy



UDFN-6L 2.0 x 2.0 x 0.5mm

High Accuracy:
• Temperature: ± 0.2 deg
Low Power

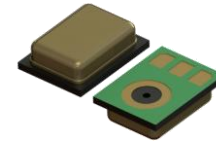


MEMS Microphones for Smart Industry

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MP23ABS1
Analog Differential Microphone

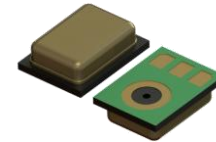


3.35x2.5x0.98 mm

Bottom Port Microphone
Analog Differential Output
Wide Acoustic Bandwidth (up to 80 kHz)
Wide Dynamic Range (AOP up to 135 dBSPL)



MP23DB01HP*
Digital Bottom Port Microphone

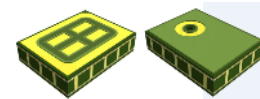


3.35x2.5x0.98 mm

Bottom Port Microphone
Multi mode PDM Output
Wide Dynamic Range (AOP up to 137 dBSPL)
Hi SNR 65.5dB



IMP34DT05
Digital Top Port Microphone



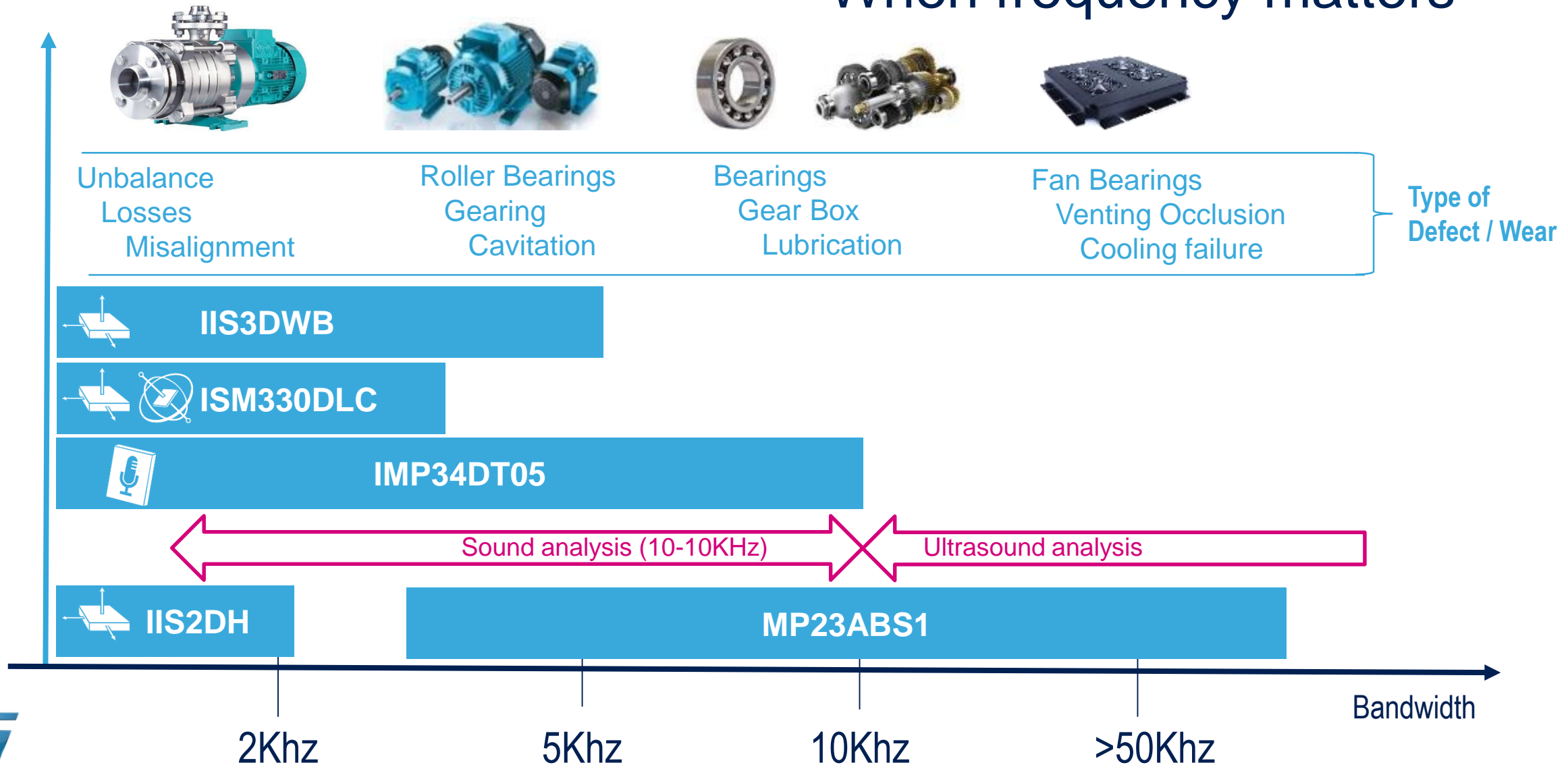
3x4x1 mm

Top Port Microphone
Digital Output
Wide dynamic range (AOP up to 122 dBSPL)
-26dBFS \pm 3 dB sensitivity

Accelerometer and Microphone

When frequency matters

30

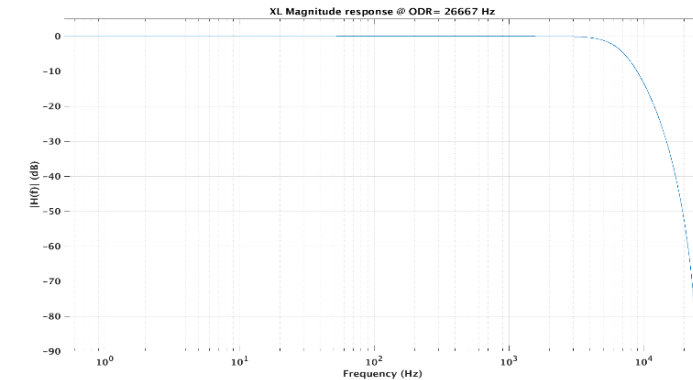


Ultra-wide Bandwidth, Low-Noise, 3-axes digital accelerometer

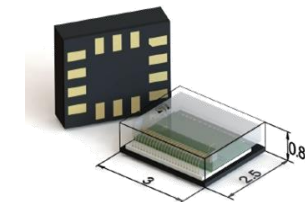
Parameter	Value
N. of axis	3-axis
Full Scale [g]	$\pm 2/\pm 4/\pm 8/\pm 16$
Output i/f	Digital: SPI
Bandwidth (-3dB) [kHz]	5
ODR [kHz]	26.7
Noise Density [$\mu\text{g}/\sqrt{\text{Hz}}$]	90 (65 in single axis)
Current Consumption [mA]	1.1
Features	FIFO (3kbyte) Programmable HP Filter Interrupts Temp. Sensor Embedded Self Test
Operating Temp [$^{\circ}\text{C}$]	-40 ; +105
Operating Voltage [V]	2.1 ÷ 3.6
Package [mm3]	LGA 2.5x3x0.83 14Lead



**3-axis Digital
Ultra Wide Bandwidth (5Khz)
Low Noise
105°C Operating Temp**



LGA-14 2.5x3mm2



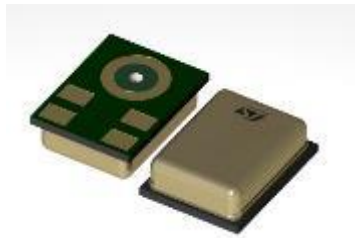
Pin2pin compatible with ISM330x/LSM6DSx devices

MP23ABS1 and IMP34DT05

Low-noise high-performance Microphones

32

RHLGA 5LD
3.5x2.65x0.98 mm



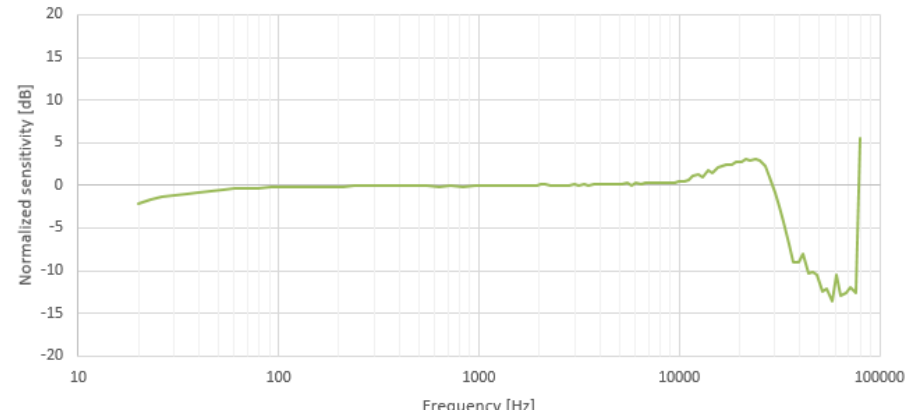
MP23ABS1

Main parameters

- Sensitivity : 38dB \pm 1dB
- SNR: 64dB(A) (min)
- AOP: 130dBSPL

- Wide Acoustic Bandwidth (up to 80 kHz)

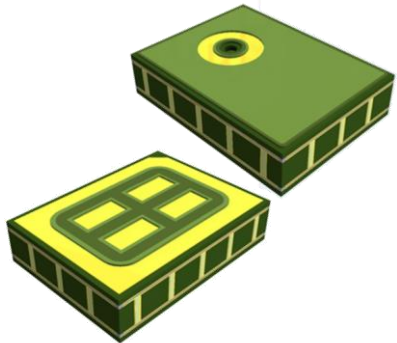
MP23ABS1 - Ultrasound Frequency response



FEATURES / BENEFITS

- Wide Dynamic range Analog single ended microphone
- Analog device enabling ultra wide bandwidth for ultrasonic detection (predictive maintenance)
- Ultra low power device for battery operated applications

HCLGA 4LD
3x4x1 mm

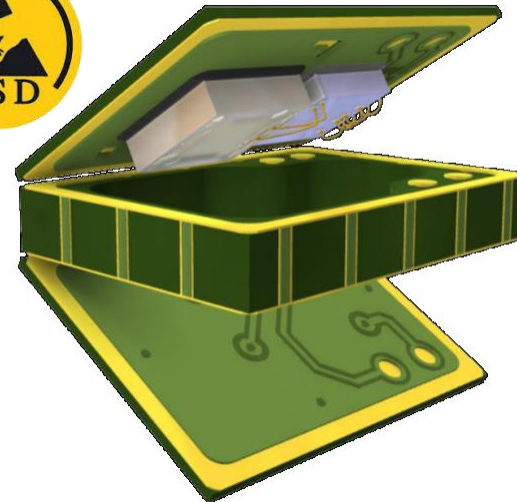


IMP34DT05

Main parameters

- Sensitivity : 26dB \pm 3dB
- SNR: 64dB(A) (typ)
- AOP: 122.5dBSPL

- High ESD protection \pm 15KV



FEATURES / BENEFITS

- High acoustic overload point to avoid sensor saturation due to loud sound detection
- Top port high robustness organic package (CbM)
- Digital output (PDM) is the optimal solution for complexity, cost and reliability



Connectivity

Connectivity Options

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Match the needs of Industrial Environments



Wired Connectivity

P2p, Industrial Fieldbus, Industrial Ethernet



And more ..

Any Industrial protocol for any STM32



Wireless Connectivity

Retrofit, flexibility of technologies and protocols, interoperability with Ethernet and Cloud





Development Kits

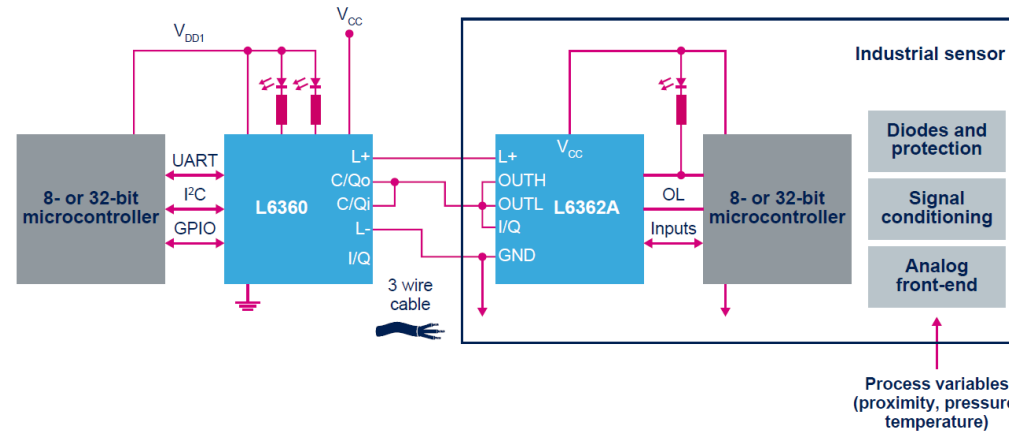
IO-Link: from ICs to a wide offering of solutions

L6360



Single port Master PHY for IO-Link and SIO mode

- Supply voltage up to 32.5 V
- Up to 200 mW max. power dissipation
- Over-voltage (>36 V) and over-temperature protection
- ESD protection according IEC 61000-4-2
- Conform to IEC 61000-4-4, IEC 61000-4-5



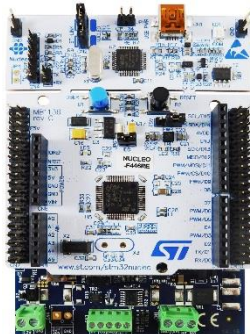
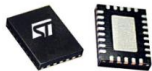
L6362A

Transceiver Device for IO-Link and SIO mode

- Configurable Output stage: High Side, Low Side, Push-Pull
- Reverse Polarity and Surge protections
- Up to 400 mA output Current with Overload and Cut-OFF protections
- 5 V or 3.3 V / 8 mA selectable linear regulator

Visit st.com for the full list of IO-Link solutions

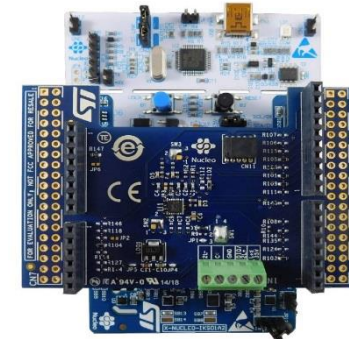
Based on **Master** L6360



The **P-NUCLEO-IOM01M1** is a STM32 Nucleo pack for IO-Link Master with IO-Link v1.1 PHY and stack



Based on **Device** L6362A



The **P-NUCLEO-IOD01A1** is a STM32 Nucleo pack for IO-Link Device fully compatible with IO-Link v1.1 PHY and stack

From Sensor to Fieldbus

Predictive maintenance kit with sensors and IO-Link capability

Use cases



Motors



Equipment



Environment



AI ready

Sensing



Vibration and Environmental

- **ISM330DLC** 6-Axis digital MEMS accel + gyro (*)
- **MP34DT05-A** Microphone
- **LPS22HB** MEMS Pressure sensor
- **HTS221** Humidity & Temperature Sensors

Connectivity



Wired

- **L6362A** IO-Link communication transceiver device IC

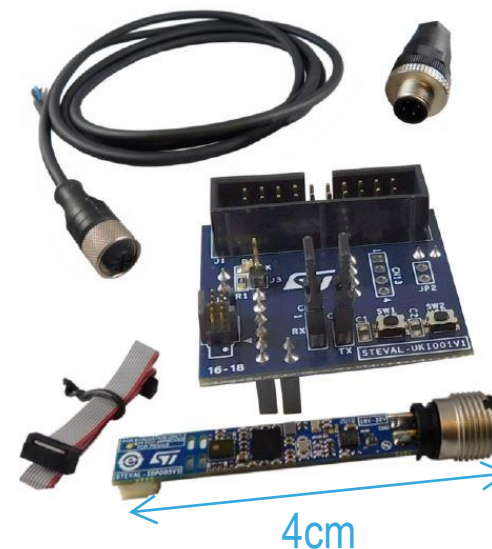
Processing



Local Processing

- **STM32F469AI** 32-bit ARM Cortex-M4 microcontroller

STEVAL-BFA001V1B



Main Features

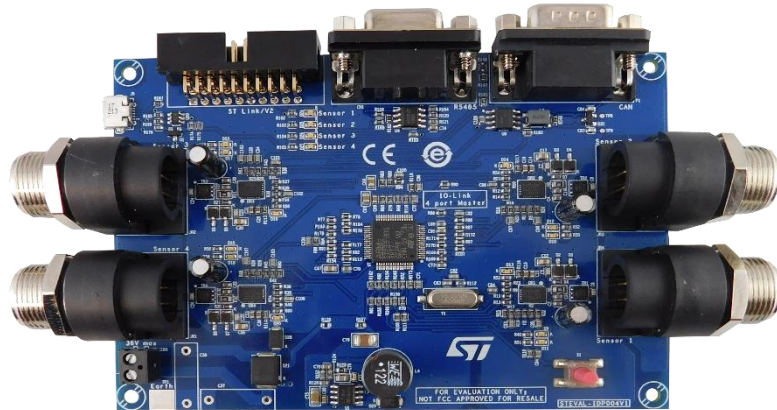
- Optimized form factor for industrial M12 connector
- Embedded algorithm for sensors data analysis, detecting anomalies like unbalance, misalignment, or bad equipment condition
- Logging of worst working condition events

STEVAL-IDP004V1

Applications with 2+ nodes to be monitored

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Adapter RS485 / USB
Optional USB



STEVAL-IDP004V1

Also available the firmware package [STSW-IO-LINK](#)



Axel spectrum



STEVAL-BFA001V1B

Download the *condition monitoring_iol* fw from the STSW-BFA001V1
Demonstration folder

Axel Peak

Speed RMS

P, T, H parameters



ST's Solutions for Cloud

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INTEGRATION

Common SW platform

4 Cloud provider SDKs supported, enabling sensor-to-cloud platforms



131 SW packages from drivers to full application examples and mobile applications



Smart Things



Smart Home



Smart City



Smart Industry



STM32 Open Development Environment



27

STM32 Nucleo development boards
Covering the broad portfolio of STM32 MCU families

>30

STM32 Nucleo expansion boards (X-NUCLEO)
Offering peripheral functions



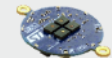
Modular hardware

ST & 3rd-party form-factor boards

SensiBLE



Discovery Kit IoT Node



Bluecoin



SensorTile



SmarTAG

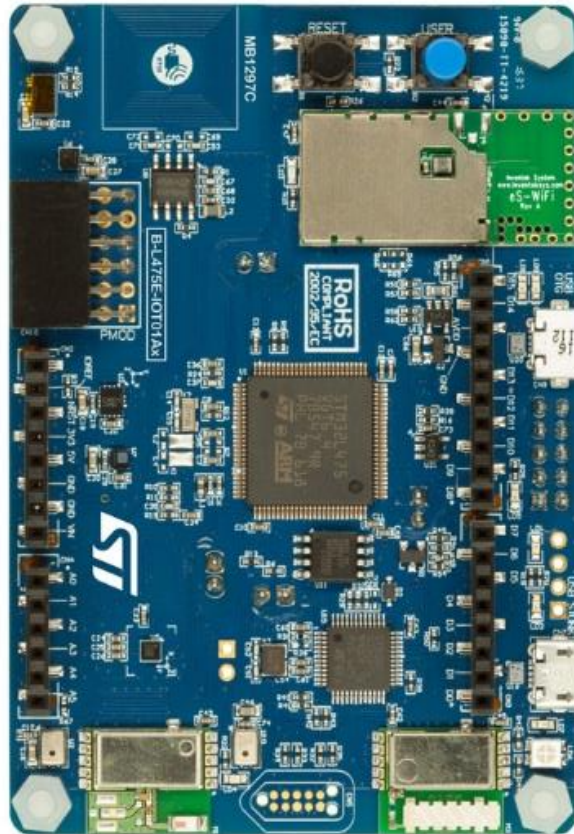
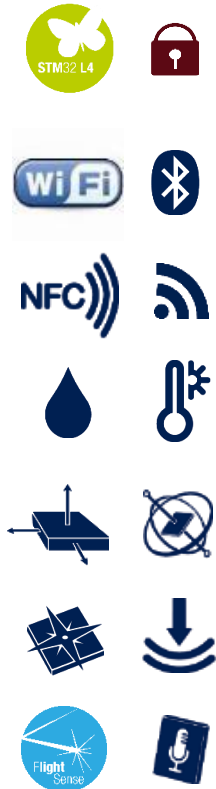
Form factor boards

STM32L475 Discovery Kit IoT Node

B-L475E-IOT01A

40

Cloud Connectivity Out-of-the-Box



- Ultra-low-power STM32L475 Arm® Cortex®-M4, 1 Mbyte Flash memory, 128 Kbytes of SRAM
- Firmware example for IoT end node connected with Wi-Fi®
 - 802.11 b/g/n compliant Wi-Fi® module
- Low Power Communications
 - Bluetooth 4.1, Sub-GHz, Dynamic NFC Tag
- Multiway Sensing
 - 3D Accelerometer, 3D Gyroscope, 3D Magnetometer, Temperature/Humidity, Pressure, Time of Flight, Microphones

STM32 Cloud Connected IoT Nodes

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• X-CUBE-AWS

- Cloud Connector: libraries and application examples

• FP-CLD-AWS1

- Companion AWS-based web dashboard

• Amazon FreeRTOS

- STM32's port of the Amazon operating system for microcontrollers that makes small, low-power edge devices easy to program, deploy, secure, connect, and manage.



NUCLEO-H743ZI



B-L475E-IOT01A



32F413HDiscovery



32F769IDiscovery



Microsoft Azure

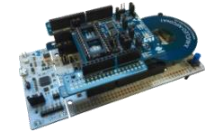


• X-CUBE-AZURE

- Cloud Connector: set of libraries and application examples

• FP-CLD-AZURE1

- Companion Dashboard with full support for Azure device management primitives and sample implementation for firmware update over the air (FOTA).



NUCLEO-F429ZI



SensorTile.box



B-L475E-IOT01A



32F413HDiscovery



32F769IDiscovery



• X-CUBE-WATSON

- Cloud Connector: libraries and application examples
- IBM Quickstart and Registered Mode support.

• FP-CLD-WATSON1

- Includes pre-integrated FFT algorithms for the processing of accelerometer



NUCLEO-F429ZI



B-L475E-IOT01A



32F413HDiscovery



32F769IDiscovery



Google Cloud

• X-CUBE-GCP

- Cloud Connector: set of libraries and application examples, MCU acting as end devices.



B-L475E-IOT01A



32F413HDiscovery



32F769IDiscovery

• X-CUBE-CLD-GEN

- Cloud Connector: libraries and application examples

Alpha
engagements

STWIN SensorTile Wireless Industrial Node

STEVAL-STWINKT1

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Use cases



Motors



Equipment



Environment

Sensing



Industrial grade sensors for

- Vibration analysis
- Sound Emission up to 80 kHz
- Environmental

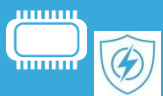
Connectivity



Embedded Wireless and Extension

- BLE, WiFi (Inventek)
- Modular expansion: LTE, LoRa, Industrial Ethernet

Processing



Local Processing & Security

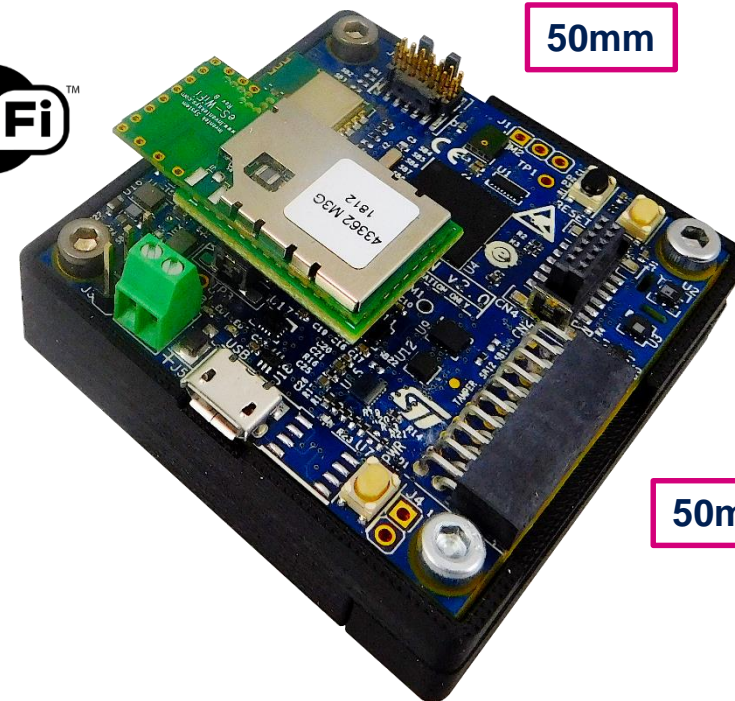
- ARM® Cortex®-M4 STM32L4R9
- Secure Element STSAFE on request

Power



Power Management

- Li-Ion linear battery charger with load switches
- Miniaturized synchronous step down converter with high efficiency conversion



AI ready



LoRa®

STM32MP157C MPU Discovery Kit

STM32MP157C-DK2

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AWS IoT Greengrass v1.8.0 Certified



- STM32MP157 Arm®-based dual Cortex®-A7 32 bits + Cortex®-M4 32 bits MPU in TFBGA361 package
 - ST PMIC STPMIC1
 - 4-Gbit DDR3L, 16 bits, 533 MHz
 - 1-Gbps Ethernet (RGMII) compliant with IEEE-802.3ab
 - USB OTG HS
 - Audio codec
 - 4 user LEDs
 - Ethernet RJ454, USB Type-A, USB Type-C™, DRPMIPI DSISM, HDMI®, headset jack including analog microphone input, micro SD™ card
 - GPIO expansion connector
 - Raspberry Pi® shields capability
 - ARDUINO® Uno V3 expansion connectors



Sensor to Cloud

From Dev Kits to End-to-End Solutions

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STEVAL-BFA001V1B

Stand Alone Sensor Node



STEVAL-IDP004V1

Expand your capabilities up to 4 Nodes



STM32MP157C-DK2

Discovery Kit



B-L475E-IOT01A

Discovery Kit IoT Node



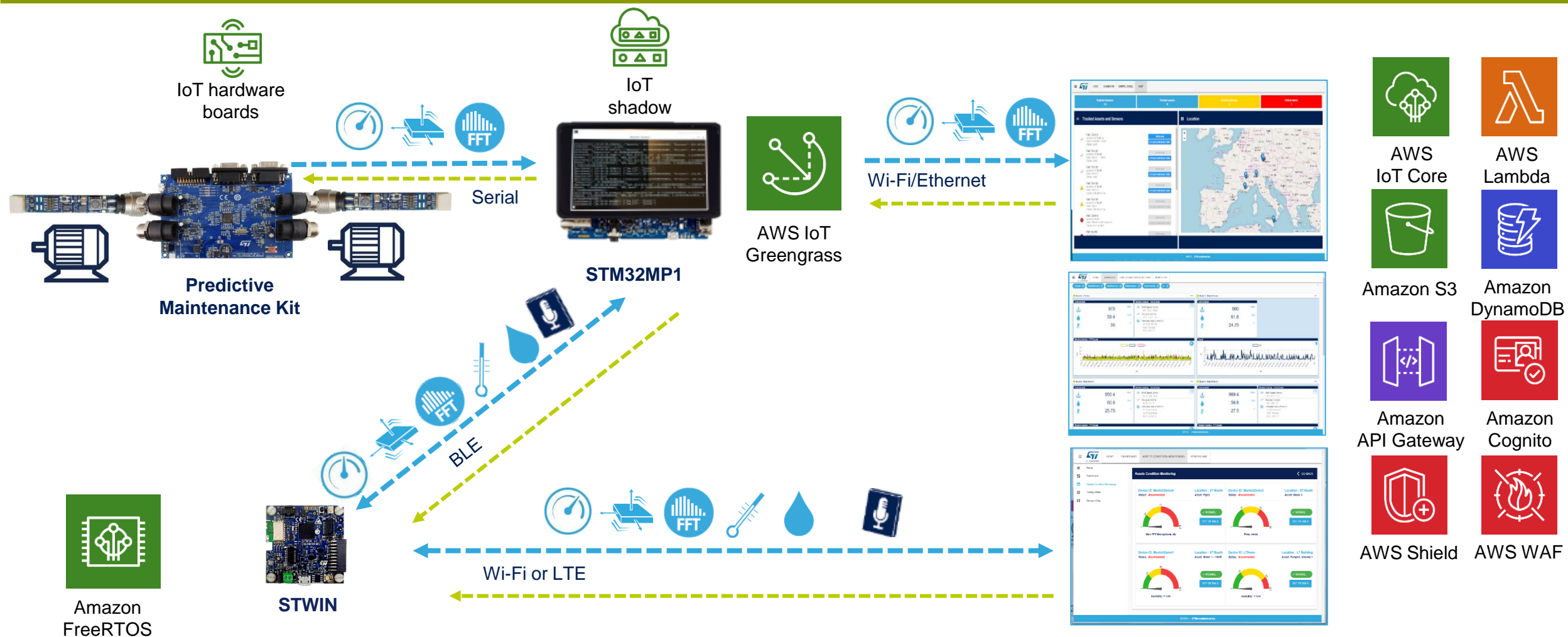
STEVAL-STWINKT1

SensorTile Wireless Industrial Node





Ultrasound, Vibration, Environmental sensing



Predictive Maintenance Solutions

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Value Proposition

Smart Sensor Nodes: different connectivity and UI to evaluate specific products

Edge and Cloud: e2e

Evaluation
FP-IND-PREDMNT1



PoC
STEVAL-BFA001V1B



Field Test: Predictive
Maintenance Platform



Understanding Needs

Full feature evaluation: Equipment/Asset Retrofitting

Framework to ingest sensors
data in the cloud and work on
insight (analysis or ML)

Same SW Library shared with same features: Vibration and Sound Analysis

- HW Available
- SW available
- BLE Data log with APP

- STEVAL-BFA001V1B and STEVAL-IDP004 available
- STWIN available end of July 2019 (Alpha Engagements)
- PC Data log, GUI and DLL for Matlab
- BLE Data log with APP

- Gateway SDK available on GitHub
- Dashboard on st.com available end of September 2019
- Cloud dashboard Data Log



life.augmented